

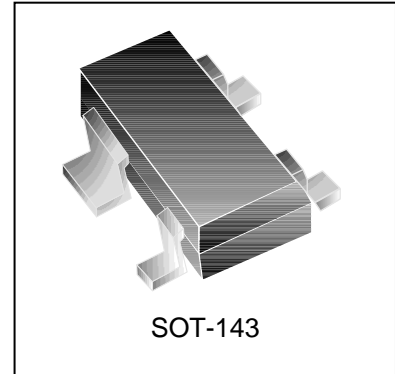
## Transient Voltage Suppressor

### Features

- Protects two I/O lines
- operating voltage: 70V
- Low capacitance(5pF typical) for high-speed interfaces
- Solid-state technology

### IEC COMPATIBILITY (EN61000-4)

- IEC 61000-4-2 (ESD)  $\pm 15\text{kV}$  (air),  $\pm 8\text{kV}$  (contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 25A (8/20 $\mu\text{s}$ )



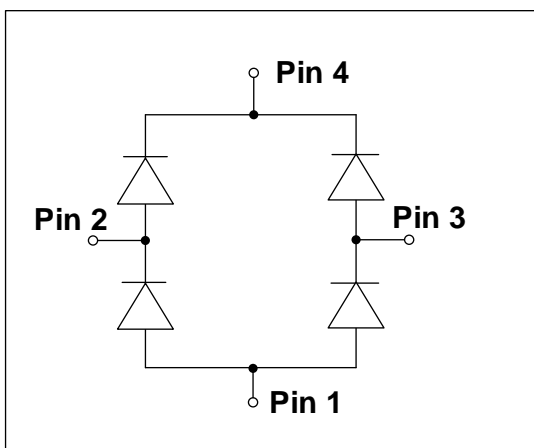
### Mechanical Characteristics

- JEDEC SOT-143 package
- Marking : Making Code
- Packaging : Tape and Reel per EIA 481
- RoHS Compliant

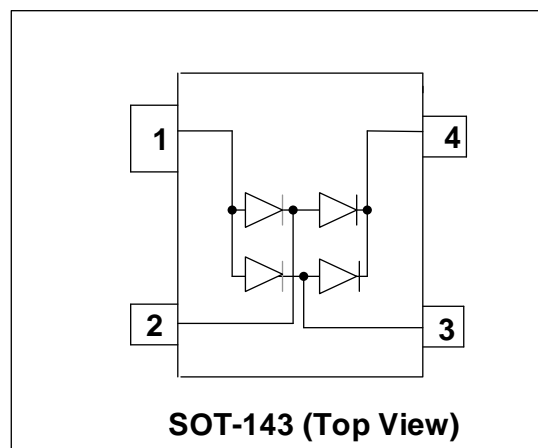
### Applications

- 10/100 Ethernet
- FireWire & USB
- Sensitive Analog Inputs
- Portable Electronics
- LAN/WAN equipment
- Video Line Protection
- Microcontroller Input Protection

### Circuit Diagram



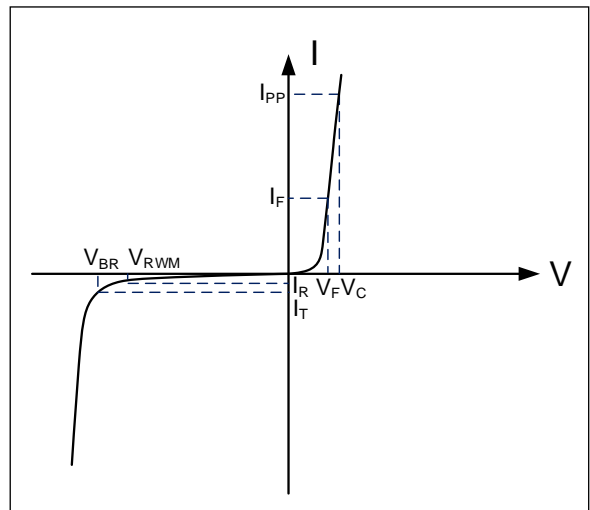
### Schematic & PIN Configuration



Absolute Maximum Rating			
Rating	Symbol	Value	Units
Peak Pulse Power ( $t_p = 8/20\mu s$ )	$P_{PP}$	350	Watts
Peak Pulse Current ( $t_p = 8/20\mu s$ )	$I_{PP}$	25	A
Operating Temperature	$T_J$	-55 to +125	$^{\circ}C$
Storage Temperature	$T_{STG}$	-55 to +150	$^{\circ}C$

Electrical Parameters (T=25 $^{\circ}C$ )

Symbol	Parameter
$I_{PP}$	Reverse Peak Pulse Current
$V_C$	Clamping Voltage @ $I_{PP}$
$V_{RWM}$	Reverse Stand-Off Voltage
$I_R$	Reverse Leakage Current @ $V_{RWM}$
$V_{BR}$	Breakdown Voltage @ $I_T$
$I_T$	Test Current
$I_F$	Forward Current
$V_F$	Forward Voltage @ $I_F$



Electrical Characteristics

WS70RH						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	$V_{RWM}$				70	V
Punch-Through Voltage	$V_{BR}$	$I_T = 1mA$	80			V
Reverse Leakage Current	$I_R$	$V_{RWM} = 70V, T = 25^{\circ}C$			2	$\mu A$
Forward Clamping Voltage	$V_C$	$I_{PP} = 1A, t_p = 8/20\mu s$		1.5	3	V
Forward Clamping Voltage	$V_C$	$I_{PP} = 10A, t_p = 8/20\mu s$		4	6	V
Forward Clamping Voltage	$V_C$	$I_{PP} = 18A, t_p = 8/20\mu s$		6.5	8	V
Forward Clamping Voltage	$V_C$	$I_{PP} = 25A, t_p = 8/20\mu s$		10.5	14	V
Junction Capacitance	$C_j$	Between I/O pins and Ground $V_R = 0V, f = 1MHz$		5	10	pF
		Between I/O pins $V_R = 0V, f = 1MHz$		3	6	pF

Typical Characteristics

Figure 1: Peak Pulse Power Vs Pulse Time

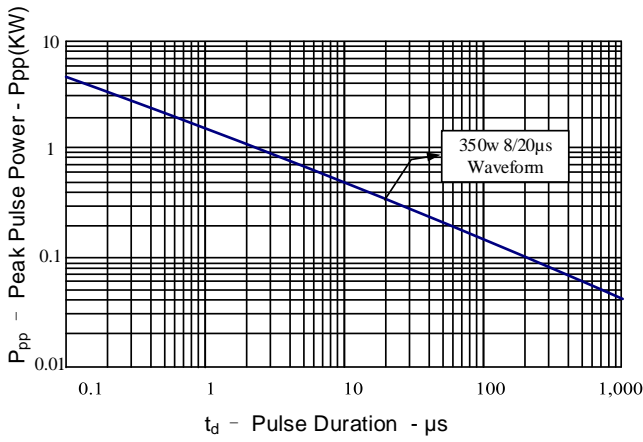


Figure 2: Power Derating Curve

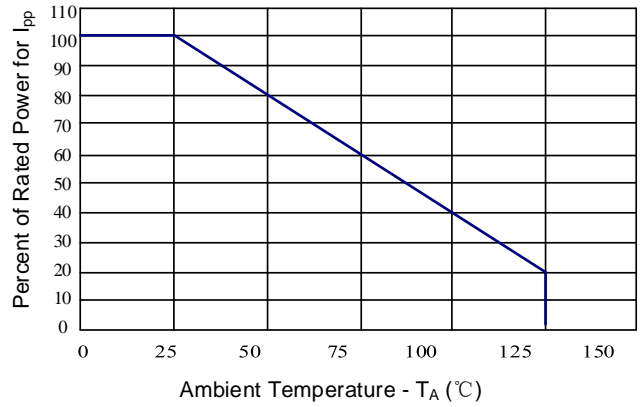


Figure 3: 8/20µs Pulse Waveform

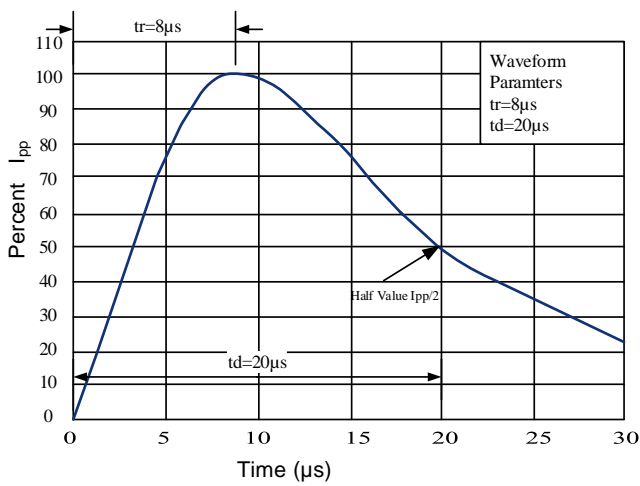
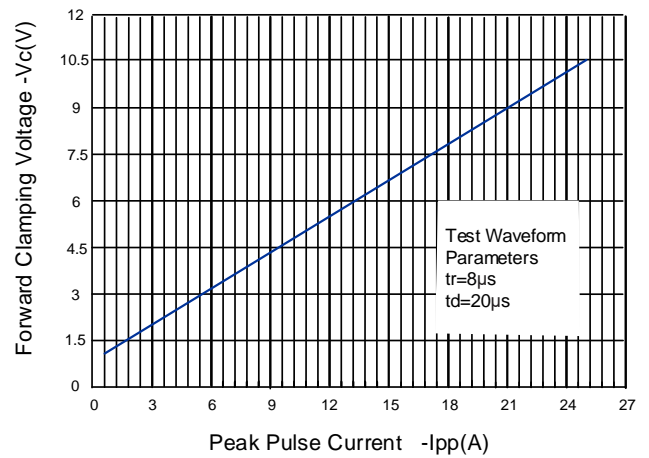
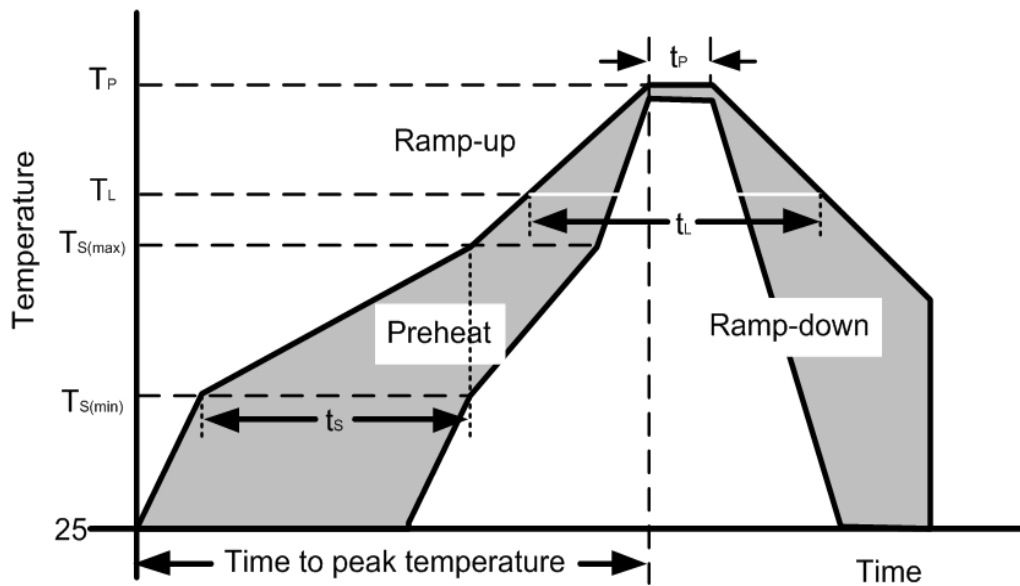


Figure 4: Forward Clamping Voltage vs. Peak Pulse Current



Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	Temperature Min ( $T_{S(min)}$ )	150°C
	Temperature Max ( $T_{S(max)}$ )	200°C
	Time (min to max) ( $t_s$ )	60 – 190 secs
Average ramp up rate (Liquidus Temp) ( $T_L$ ) to peak		5°C/second max
$T_{S(max)}$ to $T_L$ — Ramp-up Rate		5°C/second max
Reflow	Temperature ( $T_L$ ) (Liquidus)	217°C
	Temperature ( $t_l$ )	60 – 150 seconds
Peak Temperature ( $T_P$ )		260+0/-5 °C
Time within actual peak Temperature ( $t_p$ )		20 – 40 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature ( $T_P$ )		8 minutes Max.
Do not exceed		280°C



Outline Drawing – SOT-143

### PACKAGE OUTLINE

SOT-143

SYMBOL	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
b1	0.750	0.900	0.030	0.035
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
e	1.800	2.000	0.071	0.079
e1	0.200TYP		0.008TYP	
E	2.250	2.550	0.089	0.100
E1	1.200	1.400	0.047	0.055
L1	0.550REF		0.022REF	
L	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

DIMENSIONS		
DIM	INCHES	MILLIMETER S
C	.087	2.20
E1	.076	1.92
E2	.068	1.72
G	.031	0.80
X1	.039	1.00
X2	.047	1.20
Y	.055	1.40
Z	.141	3.60

**Notes:**  
Controlling Dimension: Millimeter.

Marking Codes

Part Number	Marking Code
WS70RH	

Package Information

Qty: 3k/Reel

CONTACT INFORMATION

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For additional information, please contact your local Sales Representative.

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Specifications are subject to change without notice.  
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.  
Users should verify actual device performance in their specific applications.